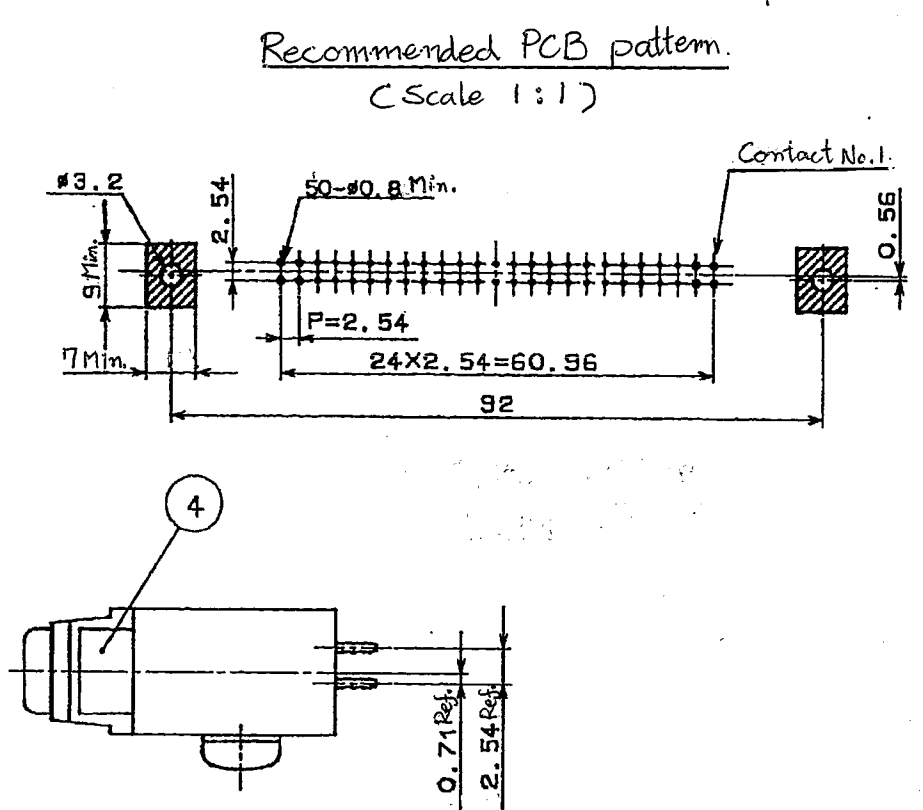




Note 1. Thickness of PCB shall be 1.6 mm.
2. Hatching area shall be pattern prohibited area.

			6	Steel	Nickel plating 3 μ m min.			
2	PBT	Black, UL94V-0	5	ZDC2	Under plating : Nickel 2 μ m min. Under plating : Copper 1 μ m min.			
1	Phosphor bronze	Contact area : Gold 0.76 μ m min. Lead area : Gold 0.03 μ m min. Under plating : Nickel 2 μ m min.	4	Phosphor bronze	Nickel plating 0.8 μ m min.			
		3	Steel	Over plating : Nickel 3 μ m min. Under plating : Copper 6 μ m min.				
NO.	MATERIAL	FINISH . REMARKS	NO.	MATERIAL	FINISH . REMARKS			
UNITS mm		SCALE 2 : 1		COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
HIROSE ELECTRIC CO., LTD.		APPROVED :	RI. TAKAYASU		18.6.11	DRAWING NO. EDC-025454-57-07		
		CHECKED :	AH. Kodama		(P-6.11)	PART NO. DN20B-50S(57)		
		DESIGNED :	P.EKSOURIYA		18.06.11	CODE NO. CL225-0048-0-57		
		DRAWN :	P.EKSOURIYA		18.06.11	1		